



Applicant: Joon-seo Son

Serial No.: 10/672,346

Att'y Docket No. 11948.12

Filing Date: September 26, 2003

For: DISCRETE PACKAGING HAVING INSULATED CERAMIC HEAT SINK

INFORMATION DISCLOSURE CITATIONS MADE BY APPLICANTU.S. Patent Documents

| EXAMINER INITIAL | DOCUMENT NUMBER | DATE | NAME |
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| <i>hm</i> | 4,067,041 | 01/03/78 | Hutson |
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| | 6,404,065 | 06/11/02 | Choi |
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| | 6,441,520 | 08/27/02 | Grant |
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| <i>↓</i> | 6,507,108 | 01/14/03 | Lindemann et al. |

Examiner:

Signature

Date Considered:

Oct 19, 2004

*EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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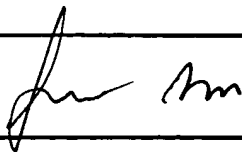
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Other Documents

| EXAMINER INITIAL | DOCUMENT |
|---|---|
|  | IXYS, HiPerFET™ Power MOSFETs ISPOLUS247™ (Electrically Isolated Backside), 2000, 2 pgs. |
|  | IXYS, HiPerFET™ Power MOSFETs ISOPLUS247™ (Electircally Isolated Back Surface), 2000, 2 pgs. |
|  | IXYS, Standard Power MOSFETs ISOPLUS247™ (Electrically Isolated Backside), 2001, 2 pgs. |

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